

Serial No.: 10/695,591  
Art Unit: 1763

### ***AMENDMENTS TO THE CLAIMS***

Please amend the claims as indicated hereafter.

***Claims:***

1. (Withdrawn) A microstructure, comprising:  
a substrate;  
an overcoat layer disposed upon the substrate;  
an air-region within at least a portion of the overcoat layer; and  
a framing material layer engaging at least a portion of the air-region on an inside surface of the framing material layer, and engaging the overcoat layer on an outside surface of the framing material layer.
2. (Withdrawn) The microstructure of claim 1, wherein the overcoat layer is selected from polyimides, polynorbornenes, epoxides, polyarylenes ethers, polyarylenes, inorganic glasses, and combinations thereof.
3. (Withdrawn) The microstructure of claim 1, wherein the framing material is selected from  $\text{SiO}_2$ ,  $\text{Si}_3\text{N}_4$ ,  $\text{SiO}_x\text{N}_y$  (where x is from 0.01 to 2 and y is from 0.01 to 1.33), and  $\text{Al}_2\text{O}_3$ .
4. (Withdrawn) The microstructure of claim 1, wherein the air-region has a height from about 0.01 to 100 micrometers and a width of about 0.1 to 10,000 micrometers.
5. (Withdrawn) The microstructure of claim 1, wherein the framing material has a thickness of about 0.001 to 10 micrometers.
6. (Withdrawn) The microstructure of claim 1, wherein the framing material has a thickness of about 0.01 to 2 micrometers.
7. (Withdrawn) The microstructure of claim 1, further comprising a plurality of air-regions disposed within the overcoat layer, the framing material layer of each of the plurality of air-regions engaging at least a portion of each air-region on the inside surface of the framing material

Serial No.: 10/695,591

Art Unit: 1763

layer and engaging the overcoat layer on the outside surface of the framing material layer.

8. (Withdrawn) The microstructure of claim 7, wherein the air-regions are positioned at multiple height levels within the overcoat layer.

9. (Withdrawn) The microstructure of claim 8, wherein a first air-region is positioned above and substantially in-line with a second air-region.

10. (Withdrawn) The microstructure of claim 8, wherein a first air-region is positioned above and substantially offset from a second air-region.

11. (Withdrawn) A microstructure, comprising:

a substrate;

an overcoat layer disposed upon the substrate;

a sacrificial polymer layer disposed within at least a portion of the overcoat layer; and

a framing material layer engaging at least a portion of the sacrificial polymer layer on an inside surface of the framing material layer and engaging the overcoat layer on an outside surface of the framing material layer.

12. (Withdrawn) The microstructure of claim 11, wherein the overcoat layer is selected from polyimides, polynorbornenes, epoxides, polyarylenes ethers, parylenes, inorganic glasses, and combinations thereof.

13. (Withdrawn) The microstructure of claim 11, wherein the framing material is selected from  $\text{SiO}_2$ ,  $\text{Si}_3\text{N}_4$ ,  $\text{SiO}_x\text{N}_y$  (where x is from 0.01 to 2 and y is from 0.01 to 1.33), and  $\text{Al}_2\text{O}_3$ .

14. (Withdrawn) The microstructure of claim 11, wherein the sacrificial layer polymer is selected from polyimides, polynorbornenes, epoxides, polyarylenes ethers, parylenes, inorganic glasses, and combinations thereof.

15. (Withdrawn) The microstructure of claim 11, wherein the sacrificial layer polymer is solvent

Serial No.: 10/695,591  
Art Unit: 1763

incompatible with the overcoat.

16. (Withdrawn) The microstructure of claim 11, wherein the sacrificial layer polymer has a height from about 0.01 to 100 micrometers and a width of about 0.1 to 10,000 micrometers.
17. (Withdrawn) The microstructure of claim 11, wherein the framing material has a thickness of about 0.001 to 10 micrometers.
18. (Currently amended) method for fabricating a microstructure, comprising:  
providing a substrate having a sacrificial polymer layer disposed thereon;  
disposing a framing material onto at least a portion of the sacrificial polymer layer; and  
disposing an overcoat layer onto the framing material, wherein the framing material substantially separates the sacrificial polymer layer from the overcoat layer; and removing the sacrificial polymer via thermal decomposition.
19. (Currently amended) The method of claim 18, ~~further comprising: wherein the step of removing the sacrificial polymer comprises~~ removing the sacrificial layer to define an air-region within the overcoat layer, the framing material engaging at least a portion of the air-region on an inside surface of the framing material and engaging the overcoat layer on an outside surface of the framing material.
20. (Original) The method of claim 18, wherein the overcoat layer is selected from polyimides, polynorbornenes, epoxides, polyarylenes ethers, parylenes, inorganic glasses, and combinations thereof.
21. (Original) The method of claim 18, wherein the framing material is selected from  $\text{SiO}_2$ ,  $\text{Si}_3\text{N}_4$ ,  $\text{SiO}_x\text{N}_y$  (where x is from 0.01 to 2 and y is from 0.01 to 1.33), and  $\text{Al}_2\text{O}_3$ .
22. (Original) The method of claim 18, wherein the sacrificial layer polymer is selected from polyimides, polynorbornenes, epoxides, polyarylenes ethers, polyarylenes, inorganic glasses, and combinations thereof.

Serial No.: 10/695,591  
Art Unit: 1763

23. (Currently amended) A method for fabricating a microstructure, comprising:

providing a structure having a substrate, an overcoat layer, a sacrificial polymer layer in an area within the overcoat layer, and a framing material ~~between at least a portion~~ covering all portions of the sacrificial polymer layer ~~and that would otherwise contact~~ the overcoat layer; and

removing the sacrificial polymer layer via thermal decomposition to form an air-region within the area defined by the sacrificial material.

24. (Original) The method of claim 23, wherein the sacrificial layer polymer is solvent-incompatible with the overcoat.

25. (Newly Added) The method of claim 23, wherein the framing material forms a barrier between the sacrificial polymer layer and the overcoat layer until the overcoat cures, and wherein the framing material maintains the dimensional integrity of the air-region.

26. (Newly Added) The method of claim 23, wherein the sacrificial layer polymer is selected from polynorbornenes, epoxides, polyarylenes ethers, polyarylenes, inorganic glasses, and combinations thereof.

27. (Newly Added) The method of claim 23, wherein the overcoat layer is selected from polyimides, polynorbornenes, polyarylenes ethers, parylenes, and combinations thereof.

28. (Newly Added) The method of claim 18, wherein the step of removing the sacrificial polymer comprises heating at least a portion of the microstructure to decomposition temperature of the sacrificial polymer.

29. (Newly Added) The method of claim 28, wherein the step of removing the sacrificial polymer comprises, after heating at least the portion of the microstructure to the decomposition temperature of the sacrificial polymer, maintaining the decomposition temperature for about 1-2 hours.

Serial No.: 10/695,591  
Art Unit: 1763

30. (Newly Added) The method of claim 18, further comprising:

allowing thermal decomposition products to diffuse through the overcoat layer leaving a virtually residue-free hollow structure.

31. (Newly Added) The method of claim 18, wherein the step of removing the sacrificial polymer via thermal decomposition comprises decomposing the sacrificial polymer layer at a temperature of about 50 to 425 °C.